

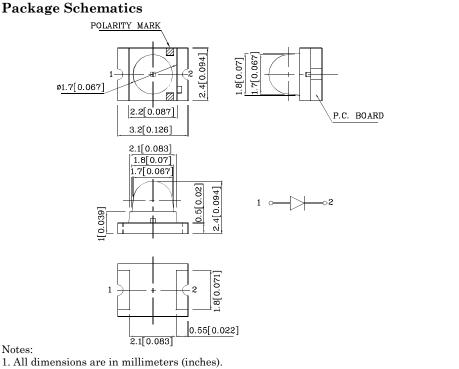
Part Number: XZMYK147W

3.2x2.4mm SMD CHIP LED LAMP

Features

- Ideal for indication light on hand held products
- Long life and robust package
- Variety of lens types and color choices available
- Package : 1500pcs / reel
- \bullet Moisture sensitivity level : level 3
- RoHS compliant





2. Tolerance is $\pm 0.1(0.004")$ unless otherwise noted.

3. Specifications are subject to change without notice.

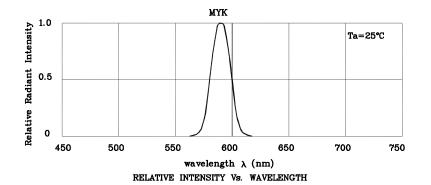
Absolute Maximum Ratings (T _A =25°C)		MYK (AlGaInP)	Unit
Reverse Voltage	V_{R}	5	V
Forward Current	\mathbf{I}_{F}	30	mA
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	ifs	175	mA
Power Dissipation	PD	75	mW
Operating Temperature	$T_{\rm A}$	$-40 \sim +85$	°C
Storage Temperature	Tstg	$-40 \sim +85$	U

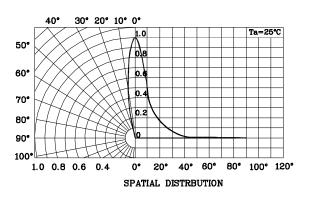
Operating Characteristics (T _A =25°C)		MYK (AlGaInP)	Unit
Forward Voltage (Typ.) (I _F =20mA)	$V_{\rm F}$	2	V
Forward Voltage (Max.) (I _F =20mA)	V_{F}	2.5	V
Reverse Current (Max.) (V _R =5V)	I_R	10	uA
Wavelength of Peak Emission (Typ.) (I _F =20mA)	λΡ	590	nm
Wavelength of Dominant Emission (Typ.) (I _F =20mA)	λD	590	nm
Spectral Line Full Width At Half-Maximum (Typ.) (I _F =20mA)	$ riangle \lambda$	20	nm
Capacitance (Typ.) (V _F =0V, f=1MHz)	С	20	\mathbf{pF}

min. typ.	
XZMYK147W Yellow AlGaInP Water Clear 800 1295 590	20°

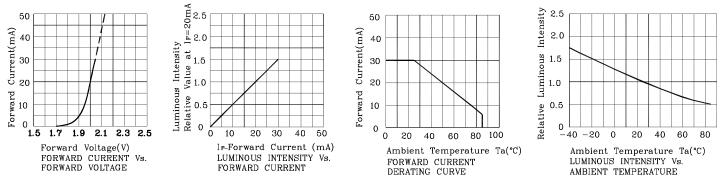
XDSB6188 V1 Layout: Maggie L.











LED is recommended for reflow soldering and soldering profile is shown below.

Reflow Soldering Profile for SMD Products (Pb-Free Components)

300 (°C) 10 s max iner? 250 4°C/s C/s max 200 150~180 4°C/s max 150 Temperature 30~50s 80~120: 100 50 0 150 0 50 100 200 250 300 (sec) Time Notes: 1. Maximum soldering temperature should not exceed 260°C

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Recommended reflow temperature: 145°C-260°C

3. Do not put stress to the epoxy resin during

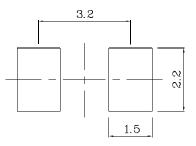
high temperatures conditions

P. 2/4

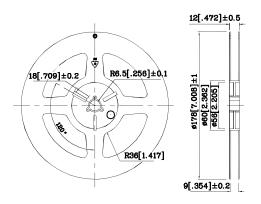


✤ The device has a single mounting surface. The device must be mounted according to the specifications.

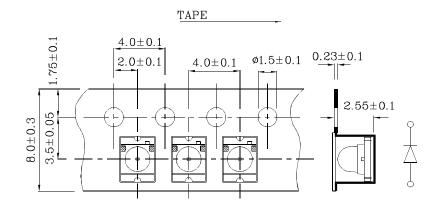
Recommended Soldering Pattern (Units : mm; Tolerance: ± 0.1)



Reel Dimension



Tape Specification (Units : mm)



Remarks:

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

1. Wavelength: +/-1nm

2. Luminous intensity / luminous flux: +/-15%

3. Forward Voltage: +/-0.1V $\,$

Note: Accuracy may depend on the sorting parameters.

Jul 01,2011



PACKING & LABEL SPECIFICATIONS

